

# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.45\text{ V}$  at  $I_F = 1.5\text{ A}$



## FEATURES

- Very low profile - typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available  
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

AUTOMOTIVE  
GRADE  
Available



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                               |                     |
|-------------------------------------------------------|---------------------|
| $I_{F(AV)}$                                           | 2 x 3 A             |
| $V_{RRM}$                                             | 100 V               |
| $I_{FSM}$                                             | 70 A                |
| $V_F$ at $I_F = 3\text{ A}$ ( $T_J = 125\text{ °C}$ ) | 0.56 V              |
| $T_J$ max.                                            | 150 °C              |
| Package                                               | SlimDPAK (TO-252AE) |
| Circuit configuration                                 | Common cathode      |

## TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

## MECHANICAL DATA

**Case:** SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

| MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ unless otherwise noted)                               |                   |             |      |
|----------------------------------------------------------------------------------------------|-------------------|-------------|------|
| PARAMETER                                                                                    | SYMBOL            | V6PW10C     | UNIT |
| Device marking code                                                                          |                   | V6PW10C     |      |
| Maximum repetitive peak reverse voltage                                                      | $V_{RRM}$         | 100         | V    |
| Maximum average forward rectified current (Fig. 1)                                           | $I_{F(AV)}^{(1)}$ | 6           | A    |
|                                                                                              |                   | 3           | A    |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode | $I_{FSM}$         | 70          | A    |
| Operating junction temperature range                                                         | $T_J^{(2)}$       | -40 to +150 | °C   |
| Storage temperature range                                                                    | $T_{STG}$         | -55 to +150 | °C   |

## Notes

(1) With infinite heatsink

(2) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

**ELECTRICAL CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                               | TEST CONDITIONS      | SYMBOL                              | TYP.  | MAX. | UNIT |
|-----------------------------------------|----------------------|-------------------------------------|-------|------|------|
| Instantaneous forward voltage per diode | $I_F = 1.5\text{ A}$ | $T_J = 25\text{ }^{\circ}\text{C}$  | 0.52  | -    | V    |
|                                         | $I_F = 3\text{ A}$   |                                     | 0.62  | 0.7  |      |
|                                         | $I_F = 1.5\text{ A}$ | $T_J = 125\text{ }^{\circ}\text{C}$ | 0.45  | -    |      |
|                                         | $I_F = 3\text{ A}$   |                                     | 0.56  | 0.63 |      |
| Reverse current per diode               | $V_R = 70\text{ V}$  | $T_J = 25\text{ }^{\circ}\text{C}$  | 0.003 | -    | mA   |
|                                         |                      | $T_J = 125\text{ }^{\circ}\text{C}$ | 1.5   | -    |      |
|                                         | $V_R = 100\text{ V}$ | $T_J = 25\text{ }^{\circ}\text{C}$  | -     | 0.15 |      |
|                                         |                      | $T_J = 125\text{ }^{\circ}\text{C}$ | 3     | 10   |      |
| Typical junction capacitance per diode  | 4.0 V, 1 MHz         | $C_J$                               | 330   | -    | pF   |

**Notes**(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle(2) Pulse test: pulse width  $\leq 5\text{ ms}$ **THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                             | SYMBOL                   | V6PW10C | UNIT                 |
|---------------------------------------|--------------------------|---------|----------------------|
| Typical thermal resistance per device | $R_{\theta JA}^{(1)(2)}$ | 65      | $^{\circ}\text{C/W}$ |
|                                       | $R_{\theta JM}^{(3)}$    | 2.5     |                      |

**Notes**(1) The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ (2) Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient(3) Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  - junction-to-mount**ORDERING INFORMATION** (Example)

| PREFERRED P/N               | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|-----------------------------|-----------------|------------------------|---------------|------------------------------------|
| V6PW10C-M3/I                | 0.20            | I                      | 4500          | 13" diameter plastic tape and reel |
| V6PW10CHM3/I <sup>(1)</sup> | 0.20            | I                      | 4500          | 13" diameter plastic tape and reel |

**Note**

(1) AEC-Q101 qualified

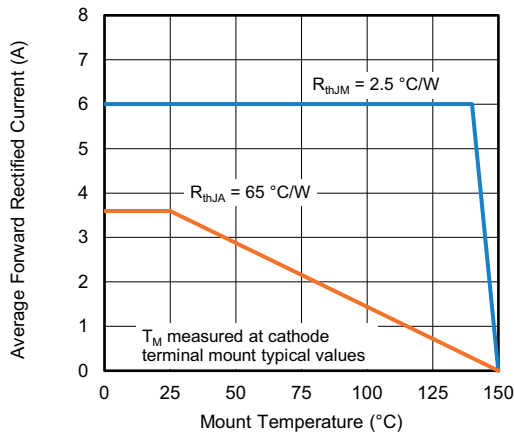
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

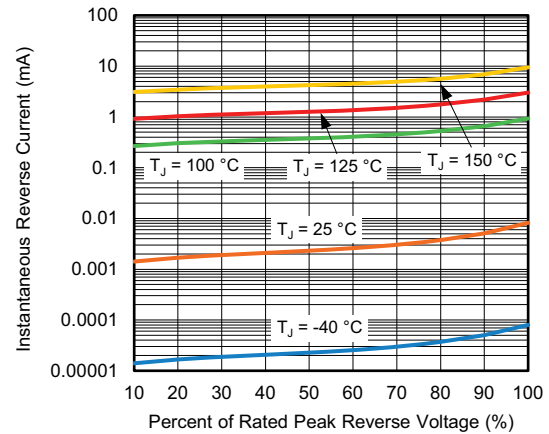


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

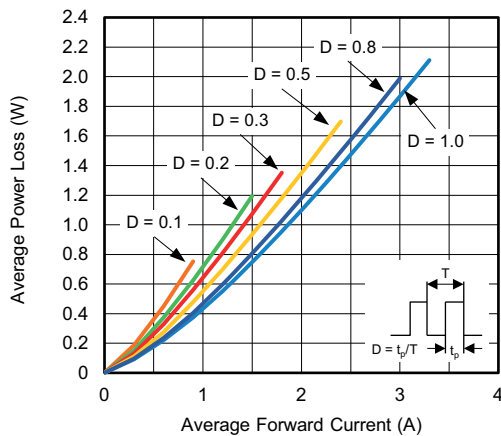


Fig. 2 - Forward Power Loss Characteristics Per Diode

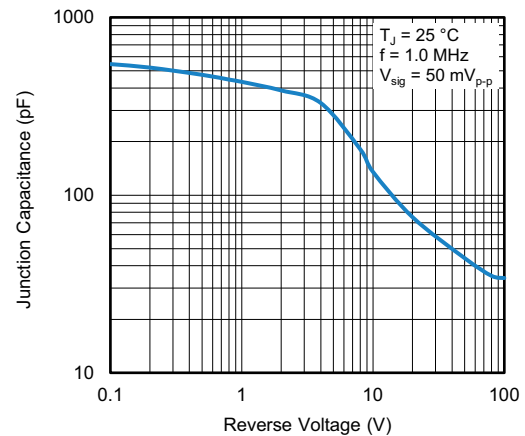


Fig. 5 - Typical Junction Capacitance Per Diode

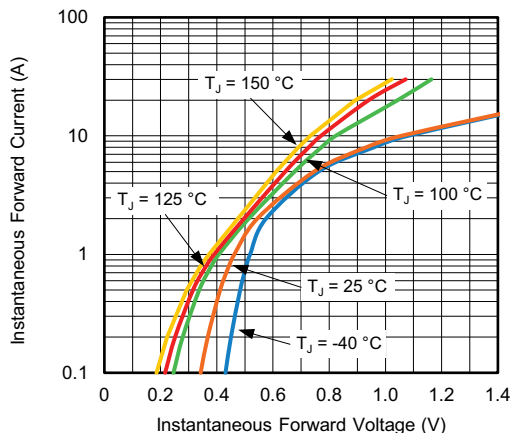


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

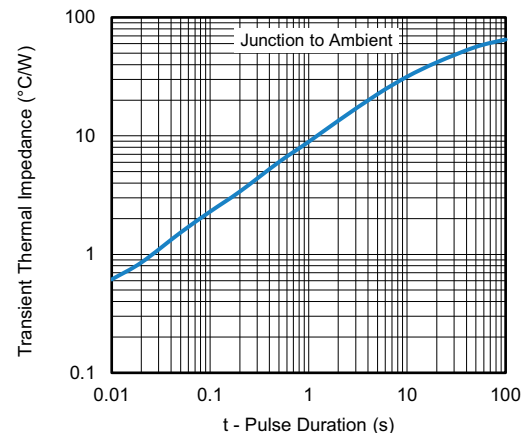


Fig. 6 - Typical Transient Thermal Impedance

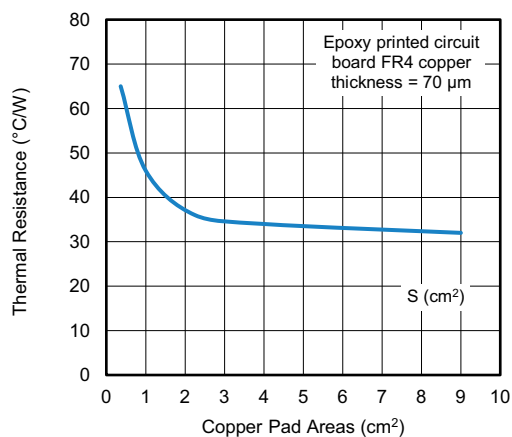
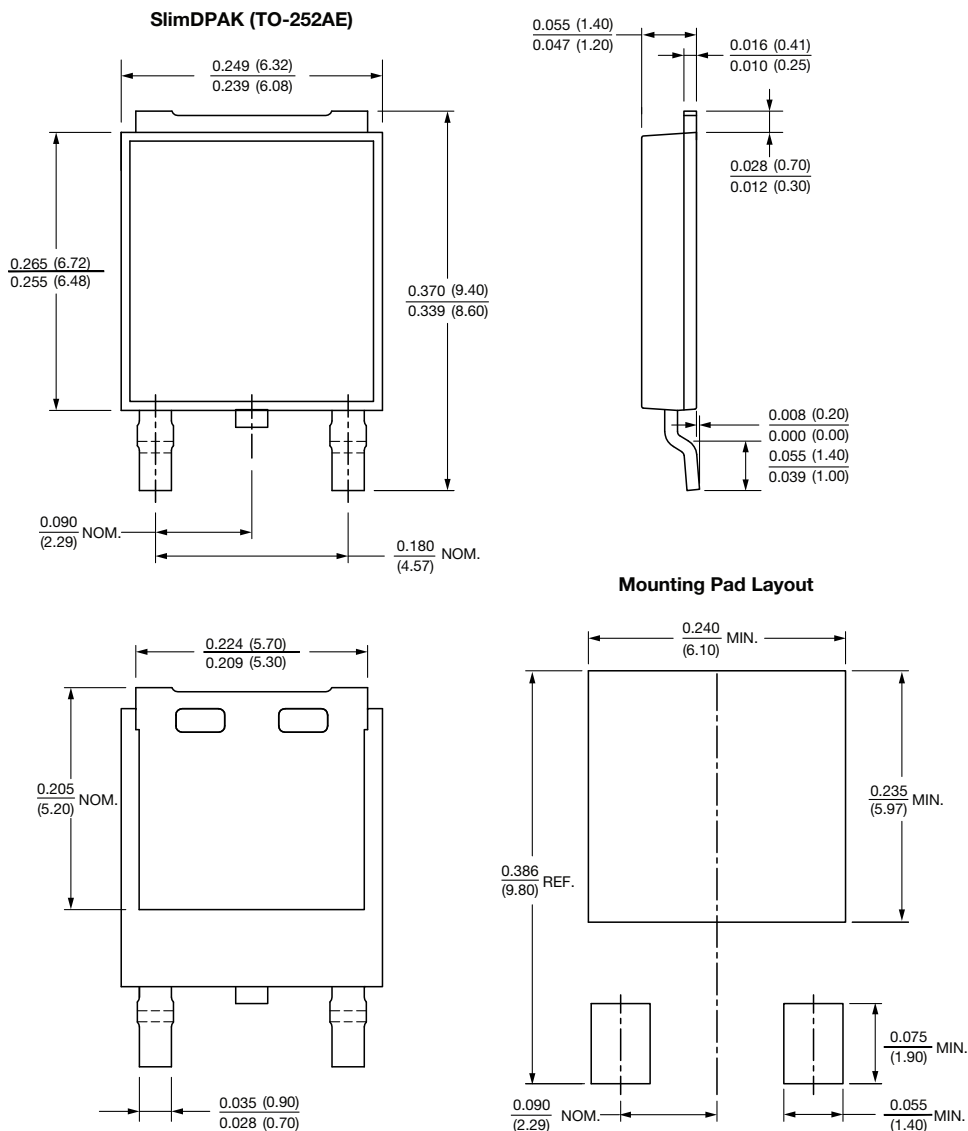


Fig. 7 - Typical Resistance Junction to Ambient vs. Copper Pad Areas

**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)




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